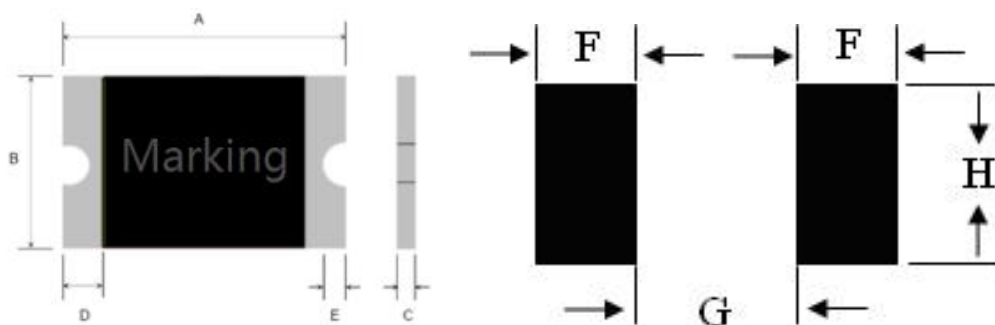


PPTC SMD0603L Series Surface-mount Devices

Features:

- RoHS Compliant & Halogen Free
- Faster tripping, 0603 Dimension, Surface mountable, Solid state
- Maximum Voltage: 6V
- Operating Current: 0.35A~3.0A,
- Operating Temperature: -40℃~ 85℃

Product Dimensions



Unit : mm

Model	Dimensions (mm)							
	A(min)	A(max)	B(min)	B(max)	C(min)	C(max)	D(min)	E(min)
SMD0603L-035-6V	1.45	1.85	0.65	1.05	0.3	0.7	0.15	0.1
SMD0603L-050-6V	1.45	1.85	0.65	1.05	0.3	0.7	0.15	0.1
SMD0603L-075-6V	1.45	1.85	0.65	1.05	0.3	0.7	0.15	0.1
SMD0603L-100-6V	1.45	1.85	0.65	1.05	0.4	1.0	0.15	0.1
SMD0603L-125-6V	1.45	1.85	0.65	1.05	0.4	1.0	0.15	0.1
SMD0603L-150-6V	1.45	1.85	0.65	1.05	0.5	1.2	0.15	0.1
SMD0603L-175-6V	1.45	1.85	0.65	1.05	0.5	1.2	0.15	0.1
SMD0603L-200-6V	1.45	1.85	0.65	1.05	0.7	1.4	0.15	0.1
SMD0603L-260-6V	1.45	1.85	0.65	1.05	0.7	1.4	0.15	0.1
SMD0603L-300-6V	1.45	1.85	0.65	1.05	0.7	1.4	0.15	0.1

Recommended Solder Pad Layout Dimensions (mm)

Device	F	G	H
	Normal Value	Normal Value	Normal Value
0603 Series	1.0	0.8	1.0

Thermal Derating Chart-IH (A)

Model	Maximum ambient operating temperatures (°C)								
	-40	-20	0	25	40	50	60	70	85
SMD0603L-035-6V	0.46	0.40	0.37	0.35	0.29	0.25	0.24	0.20	0.14
SMD0603L-050-6V	0.66	0.57	0.53	0.50	0.41	0.36	0.34	0.28	0.21
SMD0603L-075-6V	0.99	0.85	0.79	0.75	0.61	0.44	0.30	0.17	0.07
SMD0603L-100-6V	1.32	1.14	1.05	1.00	0.82	0.73	0.69	0.56	0.41
SMD0603L-125-6V	1.96	1.49	1.31	1.25	1.02	0.91	0.86	0.70	0.51
SMD0603L-150-6V	2.35	1.79	1.58	1.50	1.22	1.09	1.03	0.84	0.62
SMD0603L-175-6V	2.30	1.99	1.84	1.75	1.43	1.27	1.20	0.98	0.72
SMD0603L-200-6V	2.63	2.27	2.10	2.00	1.63	1.45	1.37	1.12	0.82
SMD0603L-260-6V	3.42	2.95	2.73	2.60	2.12	1.89	1.78	1.46	1.07
SMD0603L-300-6V	3.95	3.41	3.15	3.00	2.45	2.18	2.06	1.68	1.23

Electrical Characteristic

Model	I _{Hold}	I _{Trip}	V _{max}	I _{max}	Pd	Maximum Time to Trip		Resistance (Ω)	
	(A)	(A)	V (DC)	A	W	Current (A)	Time (s)	R _{min}	R _{max}
SMD0603L-035-6V	0.35	0.70	6.0	50.0	0.50	8.0	0.1	0.15	1.0
SMD0603L-050-6V	0.5	1.0	6.0	50.0	0.50	8.0	0.6	0.07	0.4
SMD0603L-075-6V	0.75	1.5	6.0	50.0	0.50	8.0	1.0	0.055	0.25
SMD0603L-100-6V	1.0	2.0	6.0	50.0	0.50	8.0	2.0	0.045	0.12
SMD0603L-125-6V	1.25	2.5	6.0	50.0	0.50	8.0	3.0	0.035	0.10
SMD0603L-150-6V	1.5	3.0	6.0	50.0	0.50	8.0	4.0	0.025	0.08
SMD0603L-175-6V	1.75	3.5	6.0	50.0	0.70	8.0	5.0	0.015	0.07
SMD0603L-200-6V	2.0	4.0	6.0	50.0	0.75	8.0	5.0	0.012	0.06
SMD0603L-260-6V	2.6	5.2	6.0	50.0	0.80	8.0	5.0	0.008	0.05
SMD0603L-300-6V	3.0	6.0	6.0	50.0	1.00	8.0	5.0	0.008	0.04

Test Procedures And Requirements

Test	Test Conditions	Accept/Reject Criteria
Resistance	In still air at 25°C	$R_{min} \leq R \leq R_{1max}$
Time to Trip	Specified current, V _{max} , 25°C	$T \leq T_{Maximum}$ Time to Trip
Hold Current	30min, at I _H , 25°C	No trip
Trip Cycle Life	V _{max} , I _{max} , 100 cycles	No arcing or burning
Trip Endurance	V _{max} , 1 hour	No arcing or burning

Physical Characteristics

Terminal Materials	Tin-Plated Nickle-copper
Soldering Zone	Meets EIA specification RS 186-9E and ANSI/J-STD-002 Category 3.
Moisture Sensitivity	Level 2a, per IPC/JEDEC J-STD 020C

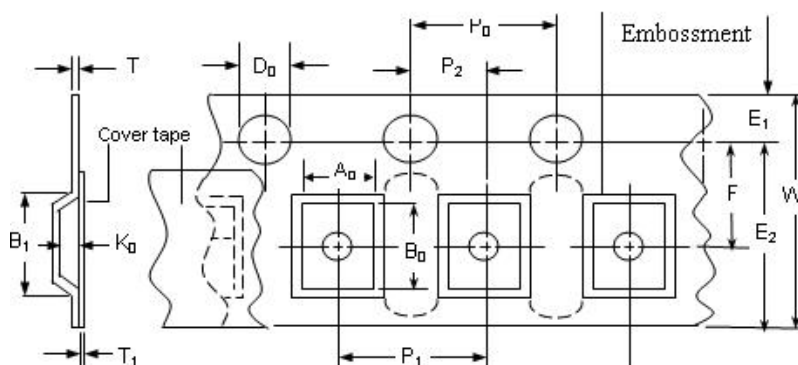
Physical Characteristics and Environmental Specifications

Test	Conditions	Resistance change
Passive aging	85°C, 1000 hours	±10% typical
Humidity aging	85°C/85%RH, 100 hours	±5% typical
Thermal shock	MIL-STD-202, Method 107G +85°C/-40°C, 20 times	-30% typical
Resistance to solvent	MIL-STD-202, Method 215	No change
Vibration	ML-STD-883C, Test Condition A	No change

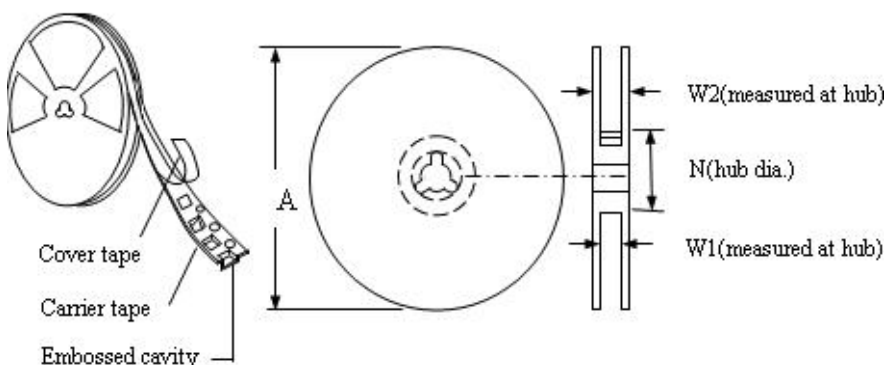
Tape Specifications and Reel Dimensions

Covering Specifications EIA 481-1	
W	8.0 ± 0.1
P ₀	4.0 ± 0.1
P ₁	4.0 ± 0.10
P ₂	2.0 ± 0.05
A ₀	0.95 ± 0.10
B ₀	1.85 ± 0.05
D ₀	1.55 ± 0.05
F	3.5 ± 0.05
E ₁	1.75 ± 0.10
T	0.20 ± 0.02
Leader min.	390
Trailer min.	160
Reel Dimensions	
A	178 ± 1
N	59 ± 1
W ₁	8.5+1.0/-0.2
W ₂	12.0±1

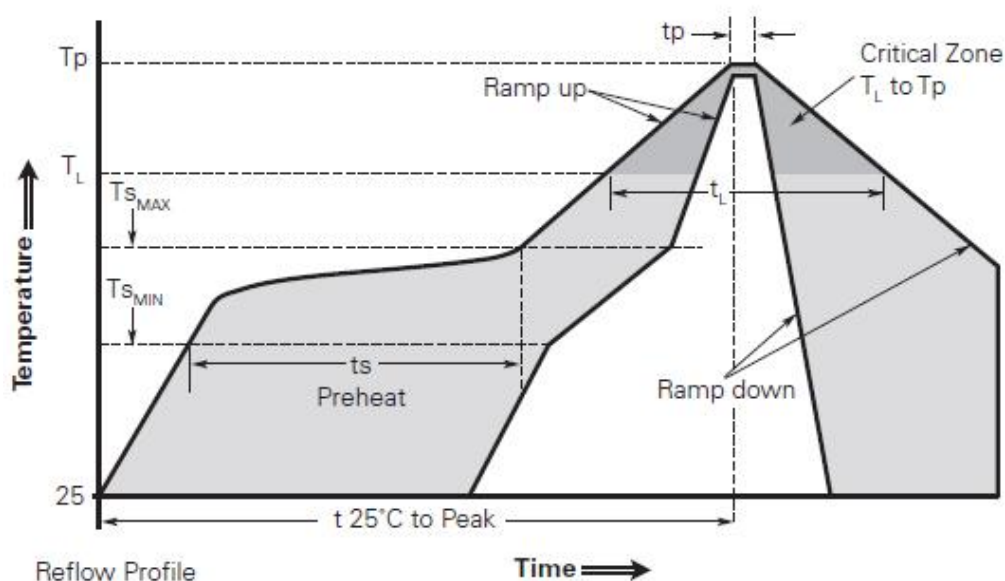
EIA Tape Component Dimensions



EIA Reel Dimensions



Solder Reflow Conditions



Profile Feature

- Average ramp up rate (TS_MAX to TP)

Pb-Free Assembly

3°C/Second max

Preheat

- Temperature min (TS_MIN)
- Temperature max (TS_MAX)
- Time (TS_MIN to TS_MAX)

150°C

200°C

60-120 Seconds

Time maintained above:

- Temperature (TL)
- Time (tL)
- Peak/Classification temperature (TP)

217°C

60-150 Seconds

260°C

Time within 5°C of actual peak temperature

- Time (TP)
- Ramp down rate
- Time 25°C to peak temperature

30 Seconds max

3°C/Second max

8 minutes max

- Recommended reflow methods: IR, vapor phase oven, hot air oven, N2 environment for lead-free.

- Devices are not designed to be wave soldered to the bottom side of the board.

- Recommended maximum paste thickness is 0.25mm (0.010inch).

- Devices can be cleaned using standard industry methods and solvents.

- Soldering temperature profile meets RoHS leadfree process.

Note: All temperatures refer to the top side of the package, measured on the package body surface.

Notes: If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

Electrical Specifications:

IH=Hold current: maximum current at which the device will not trip at 25°C still air.

IT=Trip current: minimum current at which the device will always trip at 25°C still air.

Vmax=Maximum voltage device can withstand without damage at rated current.

Imax=Maximum fault current device can withstand without damage at rated voltage.

Ttrip=Maximum time to trip (s) at assigned current.

Pd=Typical power dissipation: typical amount of power dissipated by the device when in state air environment.

Rmin=Minimum device resistance at 25°C prior to tripping.

Rmax=Maximum device resistance at 25°C prior to tripping.



Warning:

PPTC devices are intended for protection against occasional over-current or over-temperature fault conditions, and should not be used when repeated fault conditions are anticipated. Operation beyond maximum ratings of improper use may result in device damage and possible electrical arcing and flame.

Notes:

The specification is intended to present application, product and technical data to assist the user in selecting PPTC circuit protection devices. However, users should independently evaluate and test the suitability of each product. YINT makes no warranties as to the accuracy or completeness of the information and disclaims any liability resulting from its use. YINT's only obligations are those in the YINT Standard Terms and Conditions of Sale and in no case will YINT be liable for any incidental, indirect, or consequential damages arising from the sale, resale, or misuse of its products. YINT reserves the right to change or update, without notice, any information contained in this specification.